# Serial-Input Constant-Current Latched LED Drivers with Open LED Detection 

## Features and Benefits

- 3.0 to 5.5 V logic supply range
- Schmitt trigger inputs for improved noise immunity
- Power-On Reset (POR)
- Up to 90 mA constant-current sinking outputs
- LED open circuit detection
- Low-power CMOS logic and latches
- High data input rate
- 20 ns typical staggering delay on the outputs
- Internal UVLO and thermal shutdown (TSD) circuitry


## Packages:

16 and 24 pin DIP (suffix A)
16 and 24 pin TSSOP (suffix LP) 16 and 24 pin SOIC (suffix LW)

## Description

The A6278 and A6279 devices are specifically designed for LED display applications. Each of these BiCMOS devices includes a CMOS shift register, accompanying data latches, and NPN constant-current sink drivers. The A6278 contains 8 sink drivers, while there are 16 in the A6279.

The CMOS shift register and latches allow direct interfacing with microprocessor-based systems. With a 3.3 or 5 V logic supply, typical serial data-input rates can reach up to 25 MHz . supply, typical serial data-input rates can reach up to 25 MHz .
The LED drive current is determined by the user's selection of a single resistor. A CMOS serial data output permits cascading between multiple devices in applications requiring additional drive lines. Open LED connections can be detected and signaled back to the host microprocessor through the SERIAL DATA OUT pin.
Three package styles are provided: a DIP (type A) for throughhole applications; and for leaded surface-mount, an SOIC (type LW) and a TSSOP with exposed thermal pad (type LP). All package styles for the A6278 are electrically identical to each other, as are the A6279 package styles. All packages are lead $(\mathrm{Pb})$ free, with $100 \%$ matte tin plated leadframes.

Not to scale


## Serial-Input, Constant-Current Latched LED Drivers with Open LED Detection

A6279

## Selection Guide

| Part Number | Packing | Package Type | Terminals | LED Drive Lines |
| :--- | :--- | :--- | :---: | :---: |
| A6278EA-T | 25 pieces per tube | DIP |  |  |
| A6278ELP-T | 96 pieces per tube | TSSOP with exposed thermal pad | 16 | 8 |
| A6278ELPTR-T | 4000 pieces per 13-in. reel |  |  |  |
| A6278ELW-T | 47 pieces per tube | SOICW |  |  |
| A6278ELWTR-T | 1000 pieces per 13-in. reel |  |  | 16 |
| A6279EA-T | 15 pieces per tube | DIP | 24 |  |
| A6279ELP-T | 65 pieces per tube | TSSOP with exposed thermal pad |  |  |
| A6279ELPTR-T | 4000 pieces per 13-in. reel |  |  |  |
| A6279ELW-T | 31 pieces per tube | SOICW |  |  |
| A6279ELWTR-T | 1000 pieces per 13-in. reel |  |  |  |

## Absolute Maximum Ratings

| Parameter | Symbol |  | Conditions | Min. | Typ. | Max. | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| LOGIC SUPPLY Voltage Range | $V_{\text {DD }}$ |  |  | - | - | 7.0 | V |
| Load Supply Voltage Range | $\mathrm{V}_{\text {LED }}$ |  |  | -0.5 | - | 17 | V |
| OUTx Current (any single output) | $\mathrm{I}_{0}$ |  |  | - | - | 90 | mA |
| Ground Current | $\mathrm{I}_{\text {GND }}$ | A6278 |  | - | - | 750 | mA |
|  |  | A6279 |  | - | - | 1475 | mA |
| Logic Input Voltage Range | $V_{1}$ |  |  | -0.4 |  | $\begin{gathered} \mathrm{V}_{\mathrm{DD}} \\ +0.4 \end{gathered}$ | V |
| Operating Temperature Range (E) | $\mathrm{T}_{\mathrm{A}}$ |  |  | -40 | - | 85 | ${ }^{\circ} \mathrm{C}$ |
| Junction Temperature | $\mathrm{T}_{J}$ |  |  | - | - | 150 | ${ }^{\circ} \mathrm{C}$ |
| Storage Temperature Range | $\mathrm{T}_{\mathrm{S}}$ |  |  | -55 | - | 150 | ${ }^{\circ} \mathrm{C}$ |

## Serial-Input, Constant-Current Latched LED Drivers with Open LED Detection

## Pin-out Diagrams



## Terminal List Table

| Number |  | Name |  |
| :---: | :---: | :---: | :--- |
| A, LW, LP |  |  |  |
| A6278 | A6279 |  | Reference terminal for logic ground and power ground |
| 1 | 1 | GND | SERIAL DATA IN |
| 2 | 2 | CLOCK | Clock input terminal; data is shifted on the rising edge of the clock. |
| 3 | 3 | LATCH ENABLE | Data strobe input terminal; serial data is latched with a high-level input |
| 4 | 4 | OUTx | Current-sinking output terminals |
| 5 TO 12 | 5 TO 20 | OUTPUT ENABLE | (Active low) Set low to enable output drivers; set high to turn OFF <br> (blank) all output drivers |
| 13 | 21 | REXT | CMOS serial-data output; for cascading to the next device (to that <br> device SERIAL DATA IN pin); for reading OCD bits. |
| 14 | 22 | An external resistor at this terminal establishes the output current for all <br> of the sink drivers. |  |
| 15 | 23 | SERIAL DATA OUT |  |
| 16 | 24 | LOGIC SUPPLY | (VD) Logic supply voltage (typically 3.3 or 5.0 V) |
| - | - | NC | No connection |
| - | - | EP | LP and ET packages only; exposed thermal pad for heat dissipation |

# A6278 and A6279 

## Serial-Input, Constant-Current Latched LED Drivers with Open LED Detection

| Characteristic | Symbol | Test Conditions | Min. | Typ. | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| ELECTRICAL CHARACTERISTICS valid at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{DD}}=3.0$ to 5.5 V , unless otherwise noted |  |  |  |  |  |  |
| LOGIC SUPPLY Voltage Range | $V_{D D}$ | Operating | 3.0 | 5.0 | 5.5 | V |
| Undervoltage Lockout | $V_{\text {DD(UV) }}$ | $\mathrm{V}_{\mathrm{DD}}=0.0 \rightarrow 5.0 \mathrm{~V}$ | 2.4 | - | 2.85 | V |
|  |  | $\mathrm{V}_{\mathrm{DD}}=5.0 \rightarrow 0.0 \mathrm{~V}$ | 2.15 | - | 2.55 | V |
| Output Current (any single output) | Io | $\mathrm{V}_{\text {CE }}=0.7 \mathrm{~V}, \mathrm{R}_{\text {EXT }}=225 \Omega$ | 64.2 | 75.5 | 86.8 | mA |
|  |  | $\mathrm{V}_{\text {CE }}=0.7 \mathrm{~V}, \mathrm{R}_{\mathrm{EXT}}=470 \Omega$ | 34.1 | 40.0 | 45.9 | mA |
|  |  | $\mathrm{V}_{\mathrm{CE}}=0.6 \mathrm{~V}, \mathrm{R}_{\text {EXT }}=3900 \Omega$ | 4.25 | 5.0 | 5.75 | mA |
| Output Current Matching (difference between any two outputs at the same $\mathrm{V}_{\mathrm{CE}}$ ) | $\Delta \mathrm{l}_{\mathrm{O}}$ | $\mathrm{V}_{\text {CE( }(\mathrm{A})}=\mathrm{V}_{\text {CE(B) }}=0.7 \mathrm{~V}, \mathrm{R}_{\text {EXT }}=225 \Omega$ | - | $\pm 1.0$ | $\pm 6.0$ | \% |
|  |  | $\mathrm{V}_{\text {CE( }(\mathrm{A})}=\mathrm{V}_{\text {CE( }(\mathrm{B})}=0.7 \mathrm{~V}, \mathrm{R}_{\text {EXT }}=470 \Omega$ | - | $\pm 1.0$ | $\pm 6.0$ | \% |
|  |  | $\mathrm{V}_{\text {CE }(\mathrm{A})}=\mathrm{V}_{\text {CE(B) }}=0.6 \mathrm{~V}, \mathrm{R}_{\text {EXT }}=3900 \Omega$ | - | $\pm 1.0$ | $\pm 6.0$ | \% |
| Output Leakage Current | $\mathrm{I}_{\text {CEX }}$ | $\mathrm{V}_{\mathrm{OH}}=15 \mathrm{~V}$ | - | 1.0 | 5.0 | $\mu \mathrm{A}$ |
| Logic Input Voltage | $\mathrm{V}_{\mathrm{IH}}$ |  | $0.7 \mathrm{~V}_{\mathrm{DD}}$ | - | $V_{D D}$ | V |
|  | $\mathrm{V}_{\mathrm{IL}}$ |  | GND | - | $0.3 \mathrm{~V}_{\mathrm{DD}}$ | V |
| Logic Input Voltage Hysteresis | $\mathrm{V}_{\text {Ihys }}$ | All digital inputs | 200 | - | 400 | mV |
| SERIAL DATA OUT Voltage | $\mathrm{V}_{\text {OL }}$ | $\mathrm{l}_{\mathrm{OL}}=500 \mu \mathrm{~A}$ | - | - | 0.4 | V |
|  | $\mathrm{V}_{\mathrm{OH}}$ | $\mathrm{l}_{\mathrm{OH}}=-500 \mu \mathrm{~A}$ | $\mathrm{V}_{\mathrm{DD}}-0.4$ | - | - | V |
| Input Resistance | $\mathrm{R}_{1}$ | OUTPUT ENABLE input, Pull Up | 150 | 300 | 600 | k $\Omega$ |
|  |  | LATCH ENABLE input, Pull Down | 100 | 200 | 400 | k $\Omega$ |
| LOGIC SUPPLY Current | $\mathrm{l}_{\text {DD(OFF) }}$ | $\mathrm{R}_{\mathrm{EXT}}=$ open, $\mathrm{V}_{\mathrm{OE}}=5 \mathrm{~V}$ | - | - | 1.4 | mA |
|  |  | $\mathrm{R}_{\mathrm{EXT}}=470 \Omega, \mathrm{~V}_{\text {OE }}=5 \mathrm{~V}$ | - | - | 5.0 | mA |
|  |  | $\mathrm{R}_{\mathrm{EXT}}=225 \Omega, \mathrm{~V}_{\mathrm{OE}}=5 \mathrm{~V}$ | - | - | 8.0 | mA |
|  | $\mathrm{I}_{\mathrm{DD}(\mathrm{ON})}$ | $\mathrm{R}_{\text {EXT }}=3900 \Omega, \mathrm{~V}_{\text {OE }}=0 \mathrm{~V}$ | - | - | 3.0 | mA |
|  |  | $\mathrm{R}_{\text {EXT }}=470 \Omega, \mathrm{~V}_{\text {OE }}=0 \mathrm{~V}$ | - | - | 18.0 | mA |
|  |  | $\mathrm{R}_{\mathrm{EXT}}=225 \Omega, \mathrm{~V}_{\text {OE }}=0 \mathrm{~V}$ | - | - | 32.0 | mA |
| Thermal Shutdown Temperature | $\mathrm{T}_{\text {JTSD }}$ | Temperature increasing | - | 165 | - | ${ }^{\circ} \mathrm{C}$ |
| Thermal Shutdown Hysteresis | TJTSDhys |  | - | 15 | - | ${ }^{\circ} \mathrm{C}$ |
| Open LED Detection Threshold | $\mathrm{V}_{\text {CE(ODC }}$ | $\mathrm{I}_{0}>5 \mathrm{~mA}, \mathrm{~V}_{\mathrm{CE}} \geq 0.6 \mathrm{~V}$ | - | 0.30 | - | V |
| SWITCHING CHARACTERISTICS valid at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{DD}}=\mathrm{V}_{\mathrm{IH}}=3.0$ to $5.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{CE}}=0.7 \mathrm{~V}, \mathrm{~V}_{\mathrm{IL}}=0 \mathrm{~V}, \mathrm{R}_{\mathrm{EXT}}=470 \Omega, \mathrm{I}_{\mathrm{O}}=40 \mathrm{~mA}, \mathrm{~V}_{\mathrm{LED}}=3 \mathrm{~V}, \mathrm{R}_{\mathrm{LED}}=$ $58 \Omega, \mathrm{C}_{\text {LED }}=10 \mathrm{pF}$, unless otherwise noted |  |  |  |  |  |  |
| CLOCK Pulse Width | $\mathrm{t}_{\text {high, }} \mathrm{t}_{\text {low }}$ | Normal Mode | 20 | - | - | ns |
| SERIAL DATA IN Setup Time | $\mathrm{t}_{\text {SU(D) }}$ |  | 10 | - | - | ns |
| SERIAL DATA IN Hold Time | $\mathrm{t}_{\mathrm{H}(\mathrm{D})}$ |  | 10 | - | - | ns |
| LATCH ENABLE Setup Time | $\mathrm{t}_{\text {SU(LE) }}$ |  | 20 | - | - | ns |
| LATCH ENABLE Hold Time | $\mathrm{t}_{\mathrm{H}(\mathrm{LE})}$ |  | 20 | - | - | ns |
| OUTPUT ENABLE Set Up Time | $\mathrm{t}_{\text {SU(OE) }}$ |  | 40 | - | - | ns |
| OUTPUT ENABLE Hold Time | $\mathrm{t}_{\mathrm{H}(\mathrm{OE})}$ |  | 20 | - | - | ns |
| OUTPUT ENABLE Pulse Width | ${ }^{\text {tw(OE) }}$ |  | 600 | - | - | ns |
| CLOCK to SERIAL DATA OUT Propagation Delay Time | $\mathrm{t}_{\mathrm{P}(\mathrm{DO})}$ |  | 30 | - | - | ns |
| OUTPUT ENABLE to OUT0 Propagation Delay Time | $\mathrm{t}_{\mathrm{P}(\mathrm{OE})}$ |  | - | 75 | - | ns |
| Staggering Delay (between consecutive outputs) | $\mathrm{t}_{\mathrm{D}}$ |  | 10 | 20 | 40 | ns |
| Total Delay Time ( $15 \times \mathrm{t}_{\mathrm{D}}$ ) | $\mathrm{t}_{\text {Dtotal }}$ |  | - | 300 | - | ns |
| CLOCK Pulse Width | $\mathrm{t}_{\text {high, }} \mathrm{t}_{\text {low }}$ | Test Mode, $\mathrm{V}_{\mathrm{DD}}=4.5$ to 5.5 V | 20 | - | - | ns |
| SERIAL DATA IN Setup Time | $\mathrm{t}_{\text {SU( }{ }^{\text {D }} \text { ) }}$ |  | 20 | - | - | ns |
| SERIAL DATA IN Hold Time | $\mathrm{t}_{\mathrm{H}(\mathrm{D})}$ |  | 20 | - | - | ns |
| LATCH ENABLE Setup Time | $\mathrm{t}_{\text {SU(LE) }}$ |  | 40 | - | - | ns |
| LATCH ENABLE Hold Time | $\mathrm{t}_{\mathrm{H}(\mathrm{LE})}$ |  | 20 | - | - | ns |
| OUTPUT ENABLE Set Up Time | $\mathrm{t}_{\text {SU(OE) }}$ |  | 40 | - | - | ns |
| OUTPUT ENABLE Hold Time | $\mathrm{t}_{\mathrm{H} \text { (OE) }}$ |  | 20 | - | - | ns |
| OUTPUT ENABLE Pulse Width* | $\mathrm{t}_{\mathrm{W} \text { (OE) }}$ |  | 2.0 | - | - | us |
| CLOCK to SERIAL DATA OUT Propagation Delay Time | $\mathrm{t}_{\mathrm{P} \text { (DO) }}$ |  | 30 | - | - | ns |
| OUTPUT ENABLE to OUTO Propagation Delay Time | $\mathrm{t}_{\mathrm{P}(\mathrm{OE})}$ |  | - | 75 | - | ns |
| Staggering Delay (between consecutive outputs) | $t_{D}$ |  | 10 | 20 | 40 | ns |
| Total Delay Time ( $15 \times \mathrm{t}_{\mathrm{D}}$ ) | $\mathrm{t}_{\text {Dtotal }}$ |  | - | 300 | - | ns |
| Output Fall Time | $\mathrm{t}_{\mathrm{f}}$ | 90\% to 10\% voltage | - | 75 | 150 | ns |
| Output Rise Time | $\mathrm{t}_{\mathrm{r}}$ | 10\% to 90\% voltage | - | 75 | 150 | ns |

*See LED Open Circuit Detection (Test) mode timing diagram.

## Truth Table



L = Low logic (voltage) level
$\mathrm{H}=$ High logic (voltage) level
X = Don't care
$P=$ Present state
$\mathrm{R}=$ Previous state
$\mathrm{n}=7$ for the A6278, $\mathrm{n}=15$ for the A6279

Inputs and Outputs Equivalent Circuits


## Serial-Input, Constant-Current Latched LED Drivers with Open LED Detection



LED Open Circuit Detection (Test) Mode Timing Requirements
(A) To enter LED OCD mode, a minimum of one CLOCK pulse is required after LATCH ENABLE is brought back low.

(C) When returning to Normal mode, a minimum of three CLOCK pulses is required after OUTPUT ENABLE is brought back high.


# Serial-Input, Constant-Current Latched LED Drivers with Open LED Detection 

Functional Description

## Normal Mode

Serial data present at the SERIAL DATA IN input is transferred to the shift register on the logic 0-to-logic 1 transition of the CLOCK input pulse. On succeeding CLOCK pulses, the register shifts data towards the SERIAL DATA OUT pin. The serial data must appear at the input prior to the rising edge of the CLOCK input waveform.

Data present in any register is transferred to the respective latch when the LATCH ENABLE input is high (serial-to-parallel conversion). The latches continue to accept new data as long as the LATCH ENABLE input is held high.

Applications where the latches are bypassed (LATCH ENABLE tied high) will require that the OUTPUT ENABLE input be high during serial data entry. When the OUTPUT ENABLE input is high, the output sink drivers are disabled (OFF).

The data stored in the latches is not affected by the OUTPUT ENABLE input. With the OUTPUT ENABLE input active (low), the outputs are controlled by the state of their respective latches.

## LED Open Circuit Detection (Test) Mode

The LED Open Circuit Detection (OCD) mode, or Test mode, is entered by clocking in the LED OCD mode initialization sequence on the OUTPUT ENABLE (OE) and LATCH ENABLE (LE) pins. In Normal mode, the OE and LE pins do not change states while the CLOCK signal is cycling. The initialization sequence is shown in panel A of the LED OCD timing requirements diagram on page 7 .

Note: Each step event during mode sequencing happens on the leading edge of the CLOCK signal. Five step events (CLOCK pulses) are required to enter OCD mode and five step events are required to return to Normal mode.

A pattern, such as all highs, should first be loaded into the registers and latched leaving LE low. The device is then sequenced into LED OCD mode. It should be noted that data is still being sent through the shift registers while entering the LED OCD mode. However, this data is not latched when the LE pin goes high and sees a CLOCK pulse during the initialization sequence.

Open circuit detection does not take place until the sequence in Panel B on page 7 is performed. During this sequence, the OE pin must be held low for a minimum of $2 \mu \mathrm{~s}\left(\mathrm{t}_{\mathrm{W}(\mathrm{OE} 1)}\right)$ to ensure proper settling of the output currents and be given a minimum of three CLOCK pulses. During the period that the OE pin is low (active), OCD testing begins. The $\mathrm{V}_{\mathrm{CE}}$ voltage on each of the output pins is compared to the Open LED Detection Theshold, $\mathrm{V}_{\mathrm{CE}(\mathrm{OCD})}$. If the $\mathrm{V}_{\mathrm{CE}}$ of an enabled output is lower than $\mathrm{V}_{\mathrm{CE}(\mathrm{OCD})}$, an error bit value of 0 is set in the corresponding shift register. A value of 1 will be set if no error is detected. If a particular output is not enabled, a 0 will be set. The error codes are summarized in the following table:

| Output State Test Condition Error Code Meaning |  |  |  |
| :---: | :---: | :---: | :---: |
| Output State Test Condition Error Code Meaning <br> OFF N/A 0 N/A <br>  $V_{C E}<V_{C E(O C D)}$ 0 Open/TSD <br> ON $V_{C E} \geq V_{C E(O C D)}$ 1 Normal |  |  |  |

After the testing process, setting the OE pin high causes the shift registers to latch the error code data where it can then be clocked out of the SERIAL DATA OUT pin. The OCD latching sequence (OE low, 3 CLOCK pulses, OE high as shown in panel B of the LED OCD timing diagram) can then be repeated if necessary to look for intermittent contact problems.
The state of the outputs can be programmed with new data at any time while in LED OCD mode (the same as in Normal mode). This allows specific patterns to be tested for open circuits. The pattern that is latched will then be tested during the OCD latching sequence and the resulting bit values can be clocked out of the SERIAL DATA OUT pin.

Note: LED Open Circuit Detection will not work properly if the current is being externally limited by resistors to within the set current limit for the device.

To return to Normal mode, perform the clocking sequence shown in panel C of the timing diagram on the OE and LE pins.

## A6278 and <br> A6279

## Serial-Input, Constant-Current Latched LED Drivers with Open LED Detection

## Constant Current ( $\mathrm{R}_{\mathrm{EXT}}$ )

The A6278 and A6279 allow the user to set the magnitude of the constant current to the LEDs. Once set, the current remains constant regardless of the LED voltage variation, the supply voltage variation, or other circuit parameters that could otherwise
affect LED current. The output current is determined by the value of an external current-control resistor $\left(\mathrm{R}_{\mathrm{EXT}}\right)$. The relationship of these parameters is shown in figure 1. Typical characteristics for output current and $\mathrm{V}_{\mathrm{CE}}$ are shown in figure 2 for common values of $\mathrm{R}_{\text {EXT }}$.

Figure 1. Output Current versus Current Control Resistance

$$
\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{~V}_{\mathrm{CE}}=0.7 \mathrm{~V}
$$



Figure 2. Output Current versus Device Voltage Drop

$$
\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}
$$



## A6278 and A6279

## Serial-Input, Constant-Current Latched LED Drivers with Open LED Detection

## Undervoltage Lockout

The A6278 and A6279 include an internal under-voltage lockout (UVLO) circuit that disables the outputs in the event that the logic supply voltage drops below a minimum acceptable level. This feature prevents the display of erroneous information, a necessary function for some critical applications.

Upon recovery of the logic supply voltage after a UVLO event, and on power-up, all internal shift registers and latches are set to 0 . The A6278/A6279 is then in Normal mode.

## Output Staggering Delay

The A6278/A6279 has a 20 ns delay between each output. The staggering of the outputs reduces the in-rush of currents onto the power and ground planes. This aids in power supply decoupling and EMI/EMC reduction.

The output staggering delay occurs under the following conditions:

- OUTPUT ENABLE is pulled low
- OUTPUT ENABLE is held low and LATCH ENABLE is pulled high
- OUTPUT ENABLE is held low, LATCH ENABLE is held high, and CLOCK is pulled high

The 20 ns delays are cumulative across all the outputs. Under any of the above conditions, the state of OUT0 gets set after a typical propagation delay, $\mathrm{t}_{\mathrm{P}(\mathrm{OE})}$. OUT1 will get set 20 ns after OUT0, and so forth. In the A6279, OUT15 will get set after $300 \mathrm{~ns}(15 \times$ $20 \mathrm{~ns})$ plus $\mathrm{t}_{\mathrm{P}(\mathrm{OE})}$.

Note: The maximum CLOCK frequency is reduced in applications where both the OUTPUT ENABLE pin is held low and the LATCH ENABLE pin is held high continuously, and the outputs change state on the CLOCK edges. The staggering delay could cause spurious output responses at CLOCK speeds greater than 1 MHz .

## Thermal Shutdown

When the junction temperature of the A6278/A6279 reaches the thermal shutdown temperature threshold, $\mathrm{T}_{\text {JTSD }}\left(165^{\circ} \mathrm{C}\right.$ typical $)$, the outputs are shut off until the junction temperature cools down below the recovery threshold, $\mathrm{T}_{\text {JTSD }} \mathrm{T}_{\text {JTSDhys }}\left(15^{\circ} \mathrm{C}\right.$ typical $)$. The shift register and output latches will remain active during a TSD event. Therefore, there is no need to reset the data in the output latches.

In LED OCD mode, if the junction temperature reaches the Thermal Shut Down threshold, the outputs will turn off, as in Normal mode operation. However, all of the shift registers will be set with 0 , the error bit value.

## Serial-Input, Constant-Current Latched LED Drivers with Open LED Detection

## Application Information

## Load Supply Voltage ( $\mathbf{V}_{\text {LED }}$ )

These devices are designed to operate with driver voltage drops $\left(\mathrm{V}_{\mathrm{CE}}\right)$ of 0.7 to 3 V , with an LED forward voltage, $\mathrm{V}_{\mathrm{F}}$, of 1.2 to 4.0 V . If higher voltages are dropped across the driver, package power dissipation will increase significantly. To minimize package power dissipation, it is recommended to use the lowest possible load supply voltage, $\mathrm{V}_{\text {LED }}$, or to set any series voltage dropping, $\mathrm{V}_{\mathrm{DROP}}$, according to the following formula:

$$
\mathrm{V}_{\mathrm{DROP}}=\mathrm{V}_{\mathrm{LED}}-\mathrm{V}_{\mathrm{F}}-\mathrm{V}_{\mathrm{CE}},
$$

with $\mathrm{V}_{\text {DROP }}=\mathrm{I}_{\mathrm{O}} \times \mathrm{R}_{\mathrm{DROP}}$ for a single driver or for a Zener diode $\left(\mathrm{V}_{\mathrm{Z}}\right)$, or for a series string of diodes (approximately 0.7 V per diode) for a group of drivers (see figure 3). If the available voltage source, $\mathrm{V}_{\text {LED }}$, will cause unacceptable power dissipation and series resistors or diodes are undesirable, a voltage regulator can be used to provide supply voltages.
For reference, typical LED forward voltages are:

| LED Type | $\mathrm{V}_{\mathrm{F}}(\mathrm{V})$ |
| :---: | :---: |
| White | 3.5 to 4.0 |
| Blue | 3.0 to 4.0 |
| Green | 1.8 to 2.2 |
| Yellow | 2.0 to 2.1 |
| Amber | 1.9 to 2.65 |
| Red | 1.6 to 2.25 |
| Infrared | 1.2 to 1.5 |

## Pattern Layout

This device has a common logic ground and power ground terminal, GND. For the LP package, the GND pin should be tied to the exposed metal pad, EP, allowing the ground plane copper to be used to dissipate heat. If the ground pattern layout contains large common mode resistance, and the voltage between the system ground and the LATCH ENABLE, OUTPUT ENABLE, or CLOCK terminals exceeds 2.5 V (because of switching noise), these devices may not work properly.

## Package Power Dissipation ( $\mathrm{P}_{\mathrm{D}}$ )

The maximum allowable package power dissipation based on package type is determined by:

$$
\mathrm{P}_{\mathrm{D}(\max )}=\left(150-\mathrm{T}_{\mathrm{A}}\right) / \mathrm{R}_{\theta \mathrm{JA}},
$$

where $R_{\theta J \mathrm{~A}}$ is the thermal resistance of the package, determined experimentally. Power dissipation levels based on the package are shown in the Package Thermal Characteristics section (see page 14).
The actual package power dissipation is determined by:

$$
\mathrm{P}_{\mathrm{D}(\mathrm{act})}=\mathrm{DC} \times\left(\mathrm{V}_{\mathrm{CE}} \times \mathrm{I}_{\mathrm{O}} \times 16\right)+\left(\mathrm{V}_{\mathrm{DD}} \times \mathrm{I}_{\mathrm{DD}}\right),
$$

where DC is the duty cycle. The value 16 represents the maximum number of available device outputs for the A6279, used for the worst-case scenario (displaying all 16 LEDs; this would be 8 for the A6278).
When the load suppy voltage, $\mathrm{V}_{\text {LED }}$, is greater than 3 to 5 V , and $\mathrm{P}_{\mathrm{D}(\text { act })}>\mathrm{P}_{\mathrm{D}(\max )}$, an external voltage reducer ( $\mathrm{V}_{\mathrm{DROP}}$ ) must be used (see figure 3).
Reducing the percent duty cycle, DC, will also reduce power dissipation. Typical results are shown on the following pages.


Figure 3. Typical appplications for voltage drops

A6278 and
A6279

## Serial-Input, Constant-Current Latched LED Drivers with Open LED Detection

Allowable Output Current versus Duty Cycle, A6278
$V_{D D}=5 \mathrm{~V}$

A Package, $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$


LP Package, $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$


LW Package, $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$


A Package, $\mathrm{T}_{\mathrm{A}}=50^{\circ} \mathrm{C}$


LP Package, $\mathrm{T}_{\mathrm{A}}=50^{\circ} \mathrm{C}$


LW Package, $\mathrm{T}_{\mathrm{A}}=50^{\circ} \mathrm{C}$



LP Package, $\mathrm{T}_{\mathrm{A}}=85^{\circ} \mathrm{C}$


LW Package, $\mathrm{T}_{\mathrm{A}}=85^{\circ} \mathrm{C}$


# Serial-Input, Constant-Current Latched LED Drivers with Open LED Detection 

Allowable Output Current versus Duty Cycle, A6279
$V_{D D}=5 \mathrm{~V}$

A Package, $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$


LP Package, $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$


LW Package, $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$


A Package, $\mathrm{T}_{\mathrm{A}}=50^{\circ} \mathrm{C}$


DC (\%)

LP Package, $\mathrm{T}_{\mathrm{A}}=50^{\circ} \mathrm{C}$


LW Package, $\mathrm{T}_{\mathrm{A}}=50^{\circ} \mathrm{C}$


A Package, $\mathrm{T}_{\mathrm{A}}=85^{\circ} \mathrm{C}$


LP Package, $\mathrm{T}_{\mathrm{A}}=85^{\circ} \mathrm{C}$


LW Package, $\mathrm{T}_{\mathrm{A}}=85^{\circ} \mathrm{C}$


A6278 and
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## Serial-Input, Constant-Current Latched LED Drivers with Open LED Detection

## Package Thermal Characteristics

| Characteristic | Symbol | Test Conditions* | Value | Unit |
| :---: | :---: | :---: | :---: | :---: |
| Package Thermal Resistance | $\mathrm{R}_{\text {өJA }}$ | A package, 16-pin, measured on 4-layer board based on JEDEC standard | 38 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
|  |  | A package, 24-pin, measured on 4-layer board based on JEDEC standard | 26 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
|  |  | LP package, 16-pin, measured on 4-layer board based on JEDEC standard | 34 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
|  |  | LP package, 24-pin, measured on 4-layer board based on JEDEC standard | 28 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
|  |  | LW package, 16-pin, measured on 4-layer board based on JEDEC standard | 48 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
|  |  | LW package, 24-pin, measured on 4-layer board based on JEDEC standard | 44 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

*Additional thermal information is available on the Allegro Web site.


# A6278 and A6279 

## Serial-Input, Constant-Current Latched LED Drivers with Open LED Detection

Package A, 16-pin DIP (A6278)


Package A, 24-pin DIP (A6279)


Package LP, 16-pin TSSOP with Exposed Thermal Pad (A6278)


Package LP, 24-pin TSSOP with Exposed Thermal Pad (A6279)


# A6278 and A6279 

## Serial-Input, Constant-Current Latched LED Drivers with Open LED Detection

Package LW, 16-pin SOIC (A6278)


Package LW, 24-pin SOIC (A6279)


Serial-Input, Constant-Current Latched LED Drivers with Open LED Detection

The products described herein are manufactured under one or more of the following U.S. patents: 5,045,920; 5,264,783; 5,442,283; 5,389,889; 5,581,179; 5,517,112; 5,619,137; 5,621,319; 5,650,719; 5,686,894; 5,694,038; 5,729,130; 5,917,320; and other patents pending.

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